

Product/Process Change Notification

N° 2021-032-A2

Dear customer,

please find attached our Infineon Technologies AG PCN:

Introduction of an additional assembly and final test location Infineon Technologies Cegléd Kft., Cegléd, Hungary for HP Drive FS820*

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2022-01-20.
- Infineon aligns with the widely-recognized JEDEC STANDARD “JESD46”, which stipulates: “Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”
Notwithstanding the aforesaid individual agreements shall prevail.

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



On 16 April 2020, Infineon acquired Cypress.

We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance.

For further details, please visit our website:

<https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/>

Infineon Technologies AG

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Chairman of the Supervisory Board: Dr. Wolfgang Eder

Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Constanze Hufenbecher, Dr. Sven Schneider

Registered Office: Neubiberg

Commercial Register: München HRB 126492

Product/Process Change Notification

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Products affected

Please refer to attached affected product list 1_cip21032_A2

Detailed change information

Subject: Introduction of an additional assembly and final test location
Infineon Technologies Cegléd Kft., Cegléd, Hungary for HP Drive FS820*

Reason/Motivation: Expansion of assembly and final test production to assure continuity of supply and enable flexible manufacturing.

Description	Old	New
<p>PROCESS - ASSEMBLY: Move all or parts of production to a different assembly site.</p>	<p>Assembly location: Infineon Technologies AG, Warstein, Germany</p>	<p>Assembly location: Infineon Technologies AG, Warstein, Germany and Infineon Technologies Cegléd Kft., Cegléd, Hungary</p>
<p>TEST FLOW: Move of all or part of electrical wafer test and/or final test to a different test site.</p>	<p>Final test location: Infineon Technologies AG, Warstein, Germany</p>	<p>Final test location: Infineon Technologies AG, Warstein, Germany and Infineon Technologies Cegléd Kft., Cegléd, Hungary</p>

Product identification

Traceability assured via date code.
No change in SP ordering number.

Anticipated impact of change

No impact on electrical performance. Quality and reliability verified by qualification. There is no change in form, fit and function.

DeQuMa-ID(s): SEM-PA-18 / SEM-TF-01

Attachments

1_cip21032_A2 affected product list

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Time schedule

Final qualification report	available
First samples available	on request
Intended start of delivery [1]	2022-04-13
Last order date (LOD) [2]	2022-04-08
Last delivery date (LDD) [3]	2022-10-08

[1] Provided date or earlier after customer approval

[2] Last time buy volume to be placed latest until LOD

[3] Delivery of new product can be earlier (see Intended start of delivery) and depends on approval

If you have any questions, please do not hesitate to contact your local sales office.



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Infineon Technologies Cegléd Kft., Cegléd, Hungary for HP Drive FS820*

Sales name	SP number	OPN	Package
FS820R08A6P2B	SP001499708	FS820R08A6P2BBPSA1	AG-HYBRIDD-1-1
FS820R08A6P2LB	SP001611366	FS820R08A6P2LBBPSA1	AG-HYBRIDD-1-1